# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Kuo-Chih Lai	01/21/2008
Yi-Wei Chen	01/21/2008
Nien-Ting Ho	01/21/2008
Teng-Chun Tsai	01/21/2008

#### RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORP.	
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	
City:	Hsin-Chu City	
State/Country:	TAIWAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12018806

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER: WINSTON HSU

Total Attachments: 2 source=391841#page1.tif source=391841#page2.tif

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PATENT

**REEL: 020405 FRAME: 0429** 

## ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

	`	, ,			
N	Name:	Kuo-Chih Lai		Nationality:	R.O.C.
N	Name:	Yi-Wei Chen		Nationality:	R.O.C.
N	Name:	Nien-Ting Ho		Nationality:	R.O.C.
N	Vame:	Teng-Chun Tsai		Nationality:	R.O.C.
Hereby	z sells, as	signs and transfers to			
ASSIG	CNEE(S)	:			
N	Jame:	UNITED MICROELECTR	ONICS CORP.	WI SI S	
A	Address:	No.3, Li-Hsin Road 2, Scien R.O.C.	nce-Based Industrial	Park, Hsin-C	hu City 300, Taiwan,
and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:					
"Method of removing oxides"					
Which is found in:					
(a)	(a) U.S. patent application executed on even date				
(b)	(b) U.S. patent application executed on				
(c)	(c) U.S. application serial no				
(d)	p	atent no.	issued		

ASSIGNOR(S) (Inventors):

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this JAN 2 1 2008 (Date of signing). (精發明人務必簽署上列目期。)

(Type name of inventor)	Signature of INVENTOR	
Kuo-Chih Lai	Lai , Kno-chil	
Yi-Wei Chen	Yiwej chen	
Nien-Ting Ho	Niena Ting Ho.	
Teng-Chun Tsai	Teng-Chun Tsai	

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**RECORDED: 01/24/2008** 

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